Electron Transport in Modulation-Doped InAlAs/InGaAs/InAlAs Heterostructures in High Electric Fields


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Abstract

The following peculiarities of electron transport in In$_{0.52}$Ga$_{0.48}$As/In$_{0.52}$Al$_{0.48}$As quantum wells with δ-Si-doped In$_{0.15}$Al$_{0.85}$As barriers at high electric fields are discovered: (1) an enhancement of electron mobility by inserting the InAs phonon wall into the In$_{0.52}$Ga$_{0.48}$As/In$_{0.52}$Al$_{0.48}$As quantum well, as well as, as increasing the InAs content in the modulation-doped In$_{0.8}$Ga$_{0.2}$As/In$_{0.7}$Al$_{0.3}$As heterostructure; (2) a large decrease in electron mobility and a change of electron density with increasing electric field in the range of 1–4 kV/cm; (3) a magnetic field dependence of the threshold electric field for intervalley scattering of electrons; and (4) microwave current instabilities at electric fields in the terahertz frequency range [1–5]. In these structures, the Hall mobility and electron density, μH and n$_{sH}$, and electron density n$_s$(0.5) obtained from the magnetoresistance measurements in samples with length of 10 and 100 μm, at electric field $F = 0.5$ kV/cm, have been measured.

TABLE

<table>
<thead>
<tr>
<th>Sample no.</th>
<th>μH [cm$^2$ V$^{-1}$ s$^{-1}$]</th>
<th>n$_{sH}$ [10$^{12}$ cm$^{-2}$]</th>
<th>n$_s$(0.5) [10$^{12}$ cm$^{-2}$]</th>
</tr>
</thead>
<tbody>
<tr>
<td>29B</td>
<td>12300</td>
<td>1.44</td>
<td>1.5</td>
</tr>
<tr>
<td>805</td>
<td>8400</td>
<td>1.22</td>
<td>1.5</td>
</tr>
<tr>
<td>796</td>
<td>6100</td>
<td>2.53</td>
<td>2.55</td>
</tr>
<tr>
<td>804</td>
<td>6200</td>
<td>0.98</td>
<td>1.4</td>
</tr>
<tr>
<td>794</td>
<td>5500</td>
<td>3.49</td>
<td>3.2</td>
</tr>
</tbody>
</table>

Figure 1 shows the dependences of current I along the InAlAs/InGaAs/InAlAs QW layer with modulation-doped InAlAs barriers on mean electric field strength $F = U/d$, where $U$ is the applied voltage, in the samples with different source-drain lengths $d = 10$ and 100 μm. The widths of the mesa-structure and ohmic contact (Al/Ni/Ge) are 100 μm.

To separate the contributions of changes in electron mobility and electron density to the current dependence on electric fields, the mobility was determined from magnetoresistance measurements in short (10 μm) samples. Figure 2 shows the field dependences of the mobility in the investigated structures. One can see that at the fields $F = 0$–4 kV/cm, the mobility in samples 796 and 805 with the inserted InAlAs barriers, as well as in the samples with increased InAs content in the modulation-doped heterostructure are larger than that in the structures without the InAs barriers. At fields $F < 0.5$ kV/cm, the mobility in sample 29B is 1.7 times larger than in samples 794 and 804 without the barriers. The mobility in sample 805 with two inserted InAs barriers, and in sample 796 with the single InAs barrier is 1.4 and 1.1 times smaller than in the InAlAs/InGaAs/InAlAs heterostructures.
The potential local disturbance during preparation of ohmic contacts increases the electron density in the QW channel. In considered samples, this increase in the electron density \( n_s(0.5) \) determined from magnetoresistance measurements at low electric fields, \( F = 0.5 \text{ kV/cm} \), is shown in Table.

The difference in \( n_s(0.5) \) can be explained by the difference in structures of the samples and their fabrication technique. Let us note that the value of \( n_s(0.5) \) depends on the distance between ohmic contacts (length of samples) (see Table). The large electron density change at relatively low electric fields is a distinguished property of the modulation-doped heterostructures, and is not observed in conventional field-effect transistors with a homogeneously doped QW.

### 3. Negative conductivity and Gunn effect in modulation-doped structures

A negative differential conductivity in InGaAs arises due to electron intervalley transfer at high electric fields. The threshold field for the electron intervalley transfer can be estimated from the electron energy balance equation

\[
j_{th}F_{th} = \Delta_{\Gamma L}/\tau_E ,
\]

where \( j_{th} = \sigma F_{th} \), \( \sigma \) is the conductivity, \( \tau_E \) is the relaxation time of the electron energy and \( \Delta_{\Gamma L} \) corresponds to the assumed electron energy, at which the electron \( \Gamma-L \) intervalley transfer takes place. According to (1), the threshold field \( F_{th} \), and current \( I_{th} \) are equal to

\[
F_{th0} = \sqrt{\frac{\Delta_{\Gamma L}}{\tau_E \sigma}} , \quad I_{th0} = \frac{\sqrt{\Delta_{\Gamma L} \sigma}}{\tau_E} .
\]

Let us note that the threshold field \( F_{th0} \) increases and current \( I_{th0} \) decreases with decreasing the conductivity \( \sigma \) in electric fields. In bulk InGaAs, the threshold field for the intervalley transfer, \( F_{th} \), is around 5–7 kV/cm [8].

At magnetic field \( B \) applied perpendicularly to a QW plane, the conductivity in samples with short length \( d \) and wide width \( w \) (\( d \ll w \))

\[
\sigma(B) = \sigma_0 \left(1 + \mu^2 B^2\right)^{-1}.
\]

Therefore, in the short sample, the threshold field for the intervalley transfer, \( F_{th} \), increases with magnetic field,

\[
F_{th}(B) = F_{th0}\sqrt{1 + \mu^2 B^2} ,
\]

and the threshold current decreases with magnetic field,

\[
I_{th}(B) = I_{th0} \left(1 + \mu^2 B^2\right)^{-1/2} .
\]

In the long samples (\( d \sim w \)), the electric field is concentrated in the areas of the large magnetoresistance near the conductive contacts. Then at the same current, the electric field in this area is \( (1 + \mu^2 B^2) \) times larger than in the remaining part of the sample. Therefore, in the long sample, the threshold mean electric field for the intervalley transfer decreases with the increase of magnetic field

\[
F_{th}(B) = \frac{U_{th}}{d} = \frac{F_{th0}}{[1 + (\mu B)^2]^{1/2}} .
\]

Figure 3 shows the experimental dependence of the ob-
served changes of $I(U)$ in the short sample with length $d = 10 \, \mu m$. One can see the increase in the threshold voltage with increasing magnetic field strength and the decrease in the threshold current, according to (4) and (5). Figure 4 shows the $I(U)$ dependences in the longer samples with $d = 100 \, \mu m$ and $w = 100 \, \mu m$. The threshold voltage decrease (according to (6)) is observed.

The $I(U)$ dependence demonstrates the negative differential conductivity at $U > U_{th}$. The great perturbation of potential along the QW channel and therefore the change in the electron density is created when the negative differential conductivity in QW takes place. At large magnetic fields, $B > 1 \, T$, the sharp jump of the current at $U \geq U_{th}$ and the following saturation of the current is observed (see Fig. 4). As a result, the current oscillation takes place in a narrow range of applied voltages and magnetic field values. The spectrum of oscillations in the gigahertz frequency range measured using Agilent Spectrum Analyzer E 4407B is shown in Fig. 5. Let us note that the oscillations are observed in a very narrow interval of the voltage applied to the sample near to the threshold voltage $U_{th} = 22.5 \, V$. The frequencies of oscillations coincide with the drift time of electrons along the samples: $t \approx 10^{-10} \, s$ at $U_{th} \approx 22.5 \, V$.

4. Conclusions

1. The enhancement of the electron mobility by inserting an InAs phonon wall into the In$_{0.53}$Ga$_{0.47}$As/In$_{0.52}$Al$_{0.48}$As quantum well, as well as increasing the InAs content in the modulation-doped In$_{0.5}$Ga$_{0.5}$As/In$_{0.7}$Al$_{0.3}$As heterostructure is confirmed experimentally.

2. In the modulation-doped heterostructure, the decrease of the mobility and change in electron density takes place at low electric fields (1–3 kV/cm). This is a distinguished property of the modulation-doped heterostructures.

3. The magnetic field decreases the threshold current for the intervalley scattering. Current oscillations in the GHz range are observed in a narrow range of applied voltages and magnetic field values.

References


